ADLINK | AMD



ADLINK AMD Advanced Edge AI Platforms

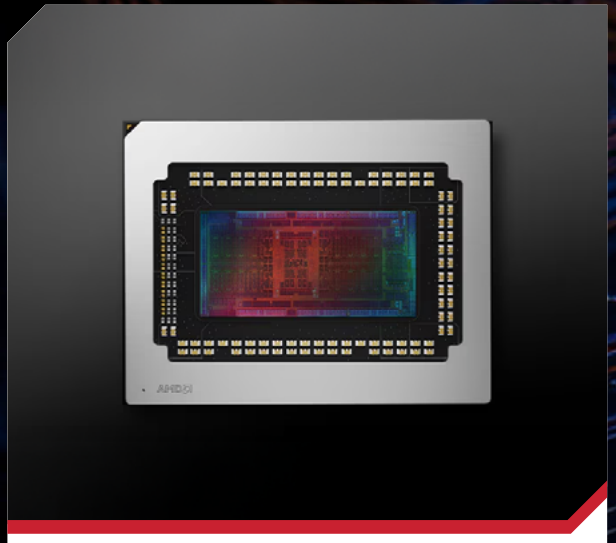
Scalable Performance for Intelligent Edge

AMD EPYC Embedded

AMD RYZEN Embedded

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Technology Highlights



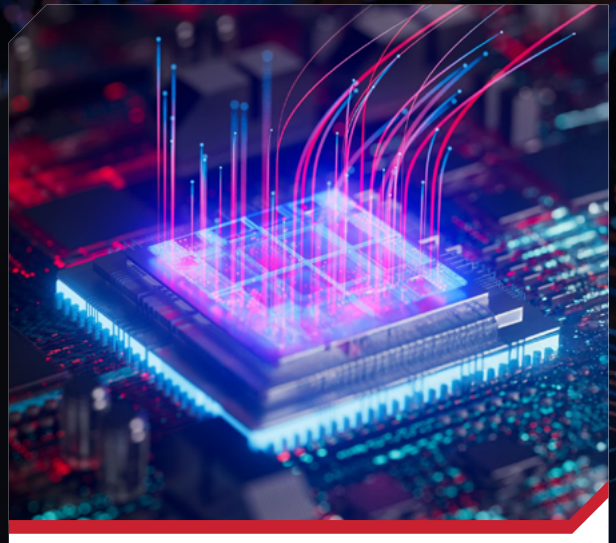
Advanced Graphics with AMD RDNA™ 3 Architecture

- Delivers stunning 4K resolution graphics performance
- Supports up to four independent displays
- Ideal for rich, multi-screen industrial and AI visualization



AI-Enhanced Video Processing

- Integrated NPU for real-time video analytics acceleration
- Supports leading codecs: AV1, H.264, and H.265
- Optimized for efficient video streaming and playback

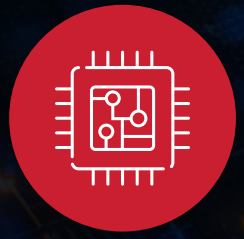


High-Speed Connectivity and Memory Reliability

- Up to 20 lanes of PCIe Gen4 for high-bandwidth expansion
- Supports DDR5 memory with ECC
- Designed for high data throughput and enhanced reliability in demanding imaging workloads

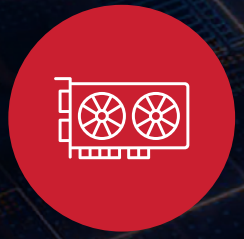
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What ADLINK x AMD Offer



High-Performance Computing

• Scalable AI-ready computing for advanced gaming, embedded, and networking applications



Graphics Capabilities

• Integrated AMD Radeon™ graphics



Seamless OS Compatibility

• Windows

• Linux

• Yocto Linux



Industrial-Grade Reliability

• Operating temperature: -40°C to 85°C

• Shock & vibration certification



Reduced TCO

• Performance per watt & cost



DMS+ Service

• End-to-end customization excellence (DMS+: Design, Manufacturing and Service)



Long Lifecycle Support

• Up to 10 years longevity (Varies by product line)



Comprehensive Testing and Validation Services

• High-speed signal verification and simulation

• HALT testing and MTBF analysis

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Product Offerings

COM Express Type 6 Compact



cExpress-R8
PICMG COM.0: Rev 3.1 Type 6 Compact

Key features
- AMD Ryzen™ Embedded 8000 Series processors
- AMD Radeon™ RDNA™ 3 graphics
- AMD XDNA™ NPU
- Up to 8x Zen4 cores at 15W-54W TDP
- Up to 96GB DDR5 (ECC/non-ECC)
- Up to 16x PCIe Gen4 lanes

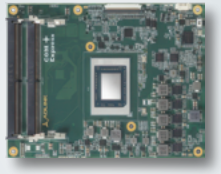
COM Express Type 6 Compact



cExpress-AR
PICMG COM.0: Rev 3.0 Type 6 Compact

Key features
- AMD Ryzen™ Embedded V2000 Processors
- Up to 4x 4K displays (DP, eDP)
- 2.5GbE Ethernet, up to 16 PCIe Gen3 lanes
- Configurable TDP down to 10W (8, 6 cores)

COM Express Type 7



Express-VR7
PICMG COM.0: Rev 3.1 Type 7 basic

Key features
- AMD Embedded Ryzen V3000 Processors
- Up to 64GB DDR5 SO-DIMM at 4800 MT/s, ECC
- 14x PCIe Gen4 lanes
- 2x 10G Ethernet, 1x 2.5G Ethernet
- Industrial temperature: -40°C to 85°C (optional)

Gaming Mini-ITX Mainboard



AmITX-RZ-G
Compact performance with flexible expansion

Key features
- AMD Ryzen Embedded R2000 processors
- Dual DDR4 SO-DIMM slots, supporting up to 32GB
- Rich expansion with PCIe Gen3 x8 (via x16 slot), PCIe Gen3 x1, M.2 and Mini-PCIe
- 4x DisplayPort outputs

Gaming Mini-ITX Mainboard



AmITX-RZ-E8K
Next-gen performance for data- and media-intensive workloads

Key features
- AMD Ryzen Embedded 8000 Processors
- Dual DDR5 SO-DIMM slots, supporting up to 64GB
- Rich expansion with PCIe Gen4 x8 (x16 slot), 2x M.2 2280 M-key, and 1x M.2 2242 B-key
- 4x DisplayPort 1.4a (HBR2)
- Integrated 7.1-channel audio and serial ports with ccTalk support

Gaming Platform



ADi-SA3X-RZ
Enterprise-grade graphics, security, and scalability

Key features
- AMD Ryzen Embedded V2000 processors
- PCIe Gen3 x8 (via x16 slot), PCIe Gen3 x1, M.2 and Mini-PCIe for broad I/O expansion
- Supports up to 8x independent displays
- Advanced security feature set
- ADLINK Advanced Gaming Architecture (AGA) reduces development time and speeds time-to-market

Gaming Platform



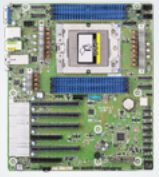
ADi-SA6X-RZ-E8K
Modern memory and I/O for future-proof embedded designs

Key features
- AMD Ryzen Embedded 8000 Processors
- Dual DDR5 SO-DIMM slots, supporting up to 64GB
- PCIe Gen4 x8 (via x16 slot) plus 2x M.2 2280 M-key and 1x M.2 2242 B-key
- 4x DisplayPort 1.4a (HBR2)
- Built-in 7.1-channel audio and ccTalk-enabled serial ports

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Product Offerings

Edge AI Server Board



ISB-TR10
CEB : Easy integration into systems

Key features
- CEB form factor 12” x 10.5” (305 x 267mm)
- Single socket SP5 (LGA 6096), supports AMD EPYC™ 9005/9004 Series processors
- 8x DIMM slots (1DPC), supports DDR5 RDIMM 6400 MT/s
- 4x PCIe5.0 x16, 2x PCIe5.0 x8, 1 MCIO (PCIe5.0 x8 or 8 SATA 6Gb/s), 4 MCIO (PCIe5.0 x8)
- 2x M.2 NVMe, 8x SATAIII slots

1U Edge AI Server



AXE-5100R7/ R9
Compact & short-depth Design

Key features
- 1U chassis with single AMD Ryzen™ 7000/9000 Series processors
- Optional PCIe slot up to 1x PCIe Gen5 x8
- Supports 1x FH, 3/4LSW GPU
- Short-depth chassis (440mm) maximizes rack space efficiency for compact deployments
- 5x smart fan speed control fans modules

2U Edge AI Server



AXE-7220TR
SFF GPU server

Key features
- Supports AMD EPYC 9005/9004 Series processors
- 2U short-depth chassis (450mm) maximizes rack space efficiency
- Up to 2x FHFLDW GPU Gen5 x16
- Up to 8x DDR5 RDIMM 6400 MT/s DIMM slots
- 4x hot-swappable fan modules and SSD drive bays

4U Edge AI Server



AXE-7440TR
High-complexity GenAI & multimodal AI

Key features
- Supports AMD EPYC 9005/9004 Series processors
- Optional PCIe slot up to 4x PCIe Gen5 x16, 3x PCIe Gen5 x8 via MICO
- Up to 4x FHFLDW GPU Gen5 x16
- Supports 6x 2.5’’ hot-swap NVMe SSD or 8x 2.5’’ hot-swap SATA SSD
- 3x Internal fan modules, 2x optional external fan modules

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Immersive Gaming Experiences – Reliable, Secure, Long-Term Value

Scenario Requirement

Next-generation slot machines require high graphics performance, long-term stability, and reliable operation in a 24/7 gaming environment. The system must support multiple high-resolution displays, secure I/O connectivity, and efficient power management, while meeting regulatory and lifecycle requirements typical of the gaming industry.

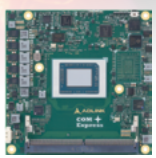
The ADLINK AmITX-RZ-G-E8K mainboard, together with the ADLINK gaming platform ADi-SA6X-RZ-E8K, leverages AMD Ryzen™ E8000 Processors to deliver strong graphics capability, compact system integration, and dependable thermal and power design suitable for casino-grade slot machine applications.

The cExpress-R8 COM Express Type 6 module, featuring DDR5 memory support, enables 4K multi-display capabilities without requiring a discrete GPU, helping to reduce total cost of ownership and accelerate time-to-market for gaming system designs.

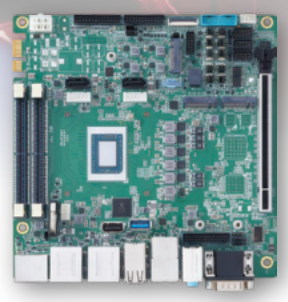
Benefits

- **Immersive Graphics:** High-quality, smooth visuals powered by AMD Ryzen™ Embedded 8000 Processors for engaging slot machine experiences
- **Multi-Display Support:** Enables gameplay, bonus, and interaction panels simultaneously
- **Gaming-Grade Reliability:** Ensures stable 24/7 performance in demanding environments
- **Secure I/O Connectivity:** Flexible support for validators, printers, buttons, and peripherals
- **Compact, Energy-Efficient Design:** Optimized for lower total cost of ownership and efficient system integration





COM Express Type 6 Compact
cExpress-R8



Gaming Mainboard
AmITX-RZ-G-E8K



Gaming Platform
ADi-SA6X-RZ-E8K

Medical Imaging AI Agent - Diagnostic Intelligence, Low-latency, Secure

Scenario Requirement

Modern diagnostic and surgical workflows increasingly depend on AI-driven analysis of high-resolution medical imaging data — both before and during procedures. Large volumes of CT scans and live imaging streams must be processed with high accuracy and minimal latency to support medical decision-making.

AI agents assist physicians by analyzing imaging data, detecting abnormalities, highlighting anatomical structures, and identifying potential risk areas. In the operating room, AI can integrate with surgical camera systems (e.g., endoscopy) to overlay real-time visual markers on high-resolution displays — enhancing situational awareness.

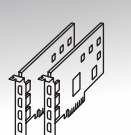
These AI workloads require powerful on-premise computing to ensure real-time responsiveness, data privacy, and reliability.

To address these requirements, the ADLINK AXE-7440TR provides a compact, high-performance edge AI platform powered by AMD EPYC™ 9005/9004 processors. The system supports up to 4x double-deck GPU/FPGA accelerator cards for real-time imaging analysis, delivering scalable performance and enhanced interoperability within space-constrained healthcare environments.

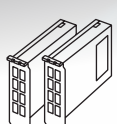
Benefits

- **Precision AI:** High-performance, low-latency computing enabling real-time surgical imaging and decision-making
- **Secure Edge Deployment:** Low-latency, cloud-independent AI services ensure patient data privacy and reliable operation





PCIE cards x 2



Frame Grabber x2



Edge AI Server (4U)
AXE-7440TR

AOI Six-Side Inspection - Accurate, High Throughput, Scalable

Scenario Requirement

Modern AOI systems for semiconductor and PCBA manufacturing require high-performance platforms to support high-camera-count inspection (e.g., six-sided inspection) within a single architecture.

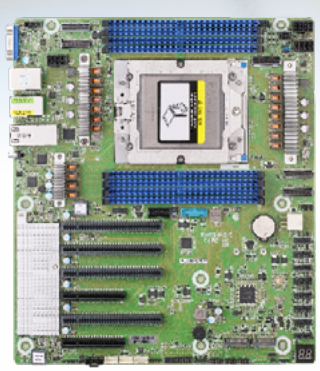
Sustaining ultra-high speed and accuracy demands simultaneous multi-channel frame grabber capture and intensive GPU acceleration — placing heavy requirements on PCIe bandwidth, system stability, and long-term reliability.

The key challenge is ensuring validated PCIe expansion and system-level compatibility to shorten bring-up time and guarantee stable 24/7 operation.

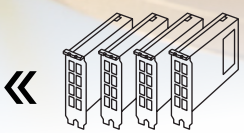
The ADLINK ISB-TR10 Edge AI Server Board enables deployment of AMD EPYC™ 9005/9004 processors in industrial imaging systems, delivering scalable PCIe bandwidth and server-class performance for complex AOI applications.

Benefits

- **High-Bandwidth Industrial Imaging:** Optimized PCIe architecture ensures massive throughput and stable 24/7 operation
- **Massive PCIe Expansion:** Supports up to 4× PCIe 5.0 x16 and 2× PCIe x8 slots for frame grabbers and GPU acceleration
- **Pre-Validated Stability:** Qualified PCIe compatibility reduces integration effort and ensures reliable continuous operation
- **Compact Server-Class Performance:** CEB form factor with AMD EPYC 9005/9004 processors delivers powerful performance in space-constrained industrial designs



Edge AI Server Board
ISB-TR10



Frame Grabber x 4



Frame Grabber Card
PCIe-10GPoE



Frame Grabber Card
PCIe-CPL64V Full

Network Cloud Appliances - High-Performance, Agile, Scalable

Scenario Requirement

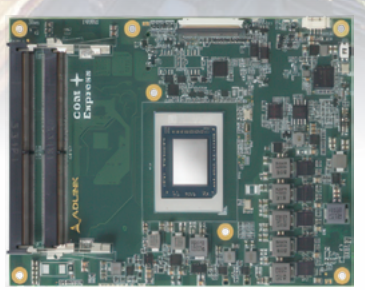
To meet the demands of hyperscalers and neoClouds, top-tier AI infrastructure developers sought an Ethernet alternative to InfiniBand that could deliver high-performance, low-latency networking for next-generation cloud and AI workloads.

This challenge was creating a platform that maximized system performance and utilization while reducing validation effort and accelerating deployment, ADLINK's COM Express Type 7 solution was selected to build a radical new "Network Cloud-AI" architecture, providing DDR5 memory support, streamlined integration, and scalable high-speed connectivity to optimize AI infrastructure efficiency and reliability.

The ADLINK COM Express Type 7 Dev Kit features the AMD Ryzen™ Embedded V3000 Processor, a low-power design ideal for edge AI deployments. It includes RunBMC remote management for secure and efficient monitoring of devices deployed anywhere.

Benefits

- **High-Performance AI Networking:** Optimized AI workloads, reduced validation effort, and faster deployment
- **DDR5 Support:** High-speed memory on COM Express Type 7 enables faster, more efficient AI data processing
- **Reduced Validation Effort:** Pre-validated platform minimizes integration time and lowers total cost of ownership (TCO)
- **Accelerated Deployment:** Streamlined design allows faster time-to-market for cloud and AI solutions



IPMB
OOB MGMT

COM Express Type 7
Express-VR7

Autonomous Welding Systems – Fast, Resilient, Intelligent

Scenario Requirement

Autonomous welding systems demand low-latency edge computing, massive computational power, and real-time 3D computer vision for AI-driven path planning in demanding industrial environments. The system must process complex sensor data, including cameras and USB-connected devices, execute heavy AI inferencing, and adapt to part variability without manual programming, all while ensuring secure local data handling.

The ADLINK Edge AI 4U Server AXE-7440TR combines server-grade multi-core processors with a flexible multi-GPU and PCIe architecture supporting up to four cards, rich I/O connectivity for cameras and USB devices, scalable memory capacity, and robust thermal and power management, delivering high-performance, secure, and reliable edge computing for autonomous welding applications.

Benefits

- **Precision Welding AI:** Massive computing power, multi-GPU support, and high-speed storage for real-time 3D vision and autonomous welding accuracy
- **High- Density AI Computing:** Supports a single server-grade AMD EPYC™ 9004/9005 processor (up to 400W) for low-latency, edge computing, and secure local AI processing. Scalable memory up to 1,024GB RDIMM handles intense robotic workloads
- **Multi-GPU & PCIe Expansion:** Accommodates up to 4x double-deck GPU/FPGA accelerator cards to drive complex 3D vision, AI pathfinding, and compute-intensive robotics tasks
- **Rich I/O & High-Speed Industrial Storage:** Supports USB devices and industrial cameras, as well as 8x 2.5" SATA SSDs or 6x 2.5" NVMe drives for rapid data logging, high-capacity storage, and secure system operation



PCIE cards x 4

Edge AI 4U Server
AXE-7440TR

Edge AI Controllers for Energy Management - Continuous, Reliable



Scenario Requirement

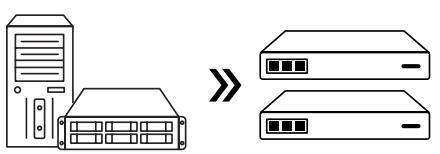
Modern energy management systems require massive computational power, real-time processing, and AI-driven decision-making for complex electricity distribution networks.

The system must execute high-speed inferencing, adapt to fluctuating grid conditions without manual intervention, and support extensive memory, multi-core processing, and local serviceability to ensure continuous, reliable operation.

By leveraging the ADLINK cExpress-R8, the customers developed a hypervisor-based industrial controller capable of managing legacy logic alongside modern AI workloads efficiently and securely.

Benefits

- **Precision Energy Management:** High-performance computing and real-time hypervisor support for reliable electricity distribution
- **High-Density Embedded Computing:** AMD Ryzen™ Embedded 8000 Series with SoC core and BIOS optimized for deterministic, low-latency control, and Type 1 Xen Domless hypervisor for secure, efficient workload separation
- **Modern OS Compatibility:** Full Windows 11 support for flexible deployment and application integration
- **Reduced TCO:** Integrated high-performance computing lowers operational costs
- **Faster Time-to-Market:** Accelerates deployment of energy management solutions



Multiple chassis variations

Two types of white boxes across the entire network

COM Express Type 6 Compact
cExpress-R8

Ultra-Secure Communication Gateway – Government-Grade Security

Scenario Requirement

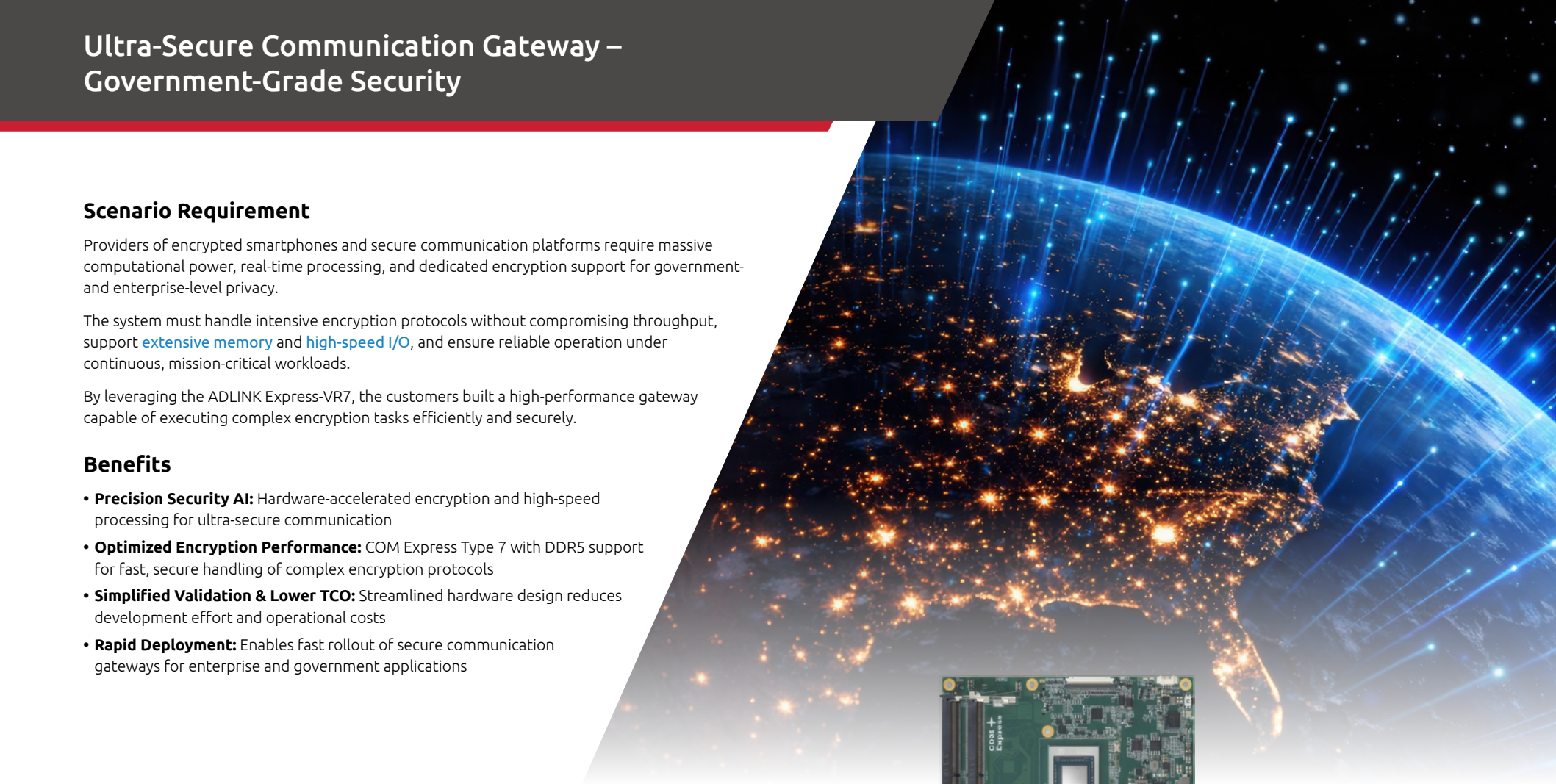
Providers of encrypted smartphones and secure communication platforms require massive computational power, real-time processing, and dedicated encryption support for government- and enterprise-level privacy.

The system must handle intensive encryption protocols without compromising throughput, support extensive memory and high-speed I/O, and ensure reliable operation under continuous, mission-critical workloads.

By leveraging the ADLINK Express-VR7, the customers built a high-performance gateway capable of executing complex encryption tasks efficiently and securely.

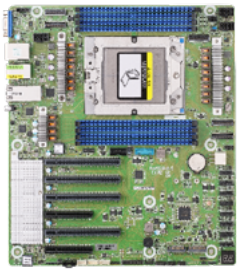
Benefits

- **Precision Security AI:** Hardware-accelerated encryption and high-speed processing for ultra-secure communication
- **Optimized Encryption Performance:** COM Express Type 7 with DDR5 support for fast, secure handling of complex encryption protocols
- **Simplified Validation & Lower TCO:** Streamlined hardware design reduces development effort and operational costs
- **Rapid Deployment:** Enables fast rollout of secure communication gateways for enterprise and government applications



COM Express Type 7
Express-VR7

Product Specifications

	cExpress-R8	cExpress-AR	Express-VR7	AmITX-RZ-G	AmITX-RZ-G-E8K	ISB-TR10
	 COM Express Type 6 Compact	 COM Express Type 6 Compact	 COM Express Type 7	 Gaming Mini-ITX Mainboard	 Gaming Mini-ITX Mainboard	 Server Motherboard
AMD Processor	AMD Ryzen™ Embedded 8000 Series Processors	AMD Ryzen Embedded V2000 Processors	AMD Ryzen Embedded V3000 Processors	AMD Ryzen Embedded R2000 Processors	AMD Ryzen Embedded 8000 Processors	AMD EPYC™ 9005/9004 Series Processors
Memory	Up to 96GB DDR5 SO-DIMM	Up to 64GB DDR4 SO-DIMM	Up to 64GB DDR5 SO-DIMM	Dual Channel DDR4 3200 ECC SO-DIMM Up to 32GB	Dual Channel DDR5 5600 SO-DIMM Up to 64GB	8x DIMM DDR5 6400 R-DIMM MT/s Up to 1 TB
BIOS	AMI	AMI	AMI	AMI EFI in 16MB SPI BIOS	AMI EFI in 32MB SPI BIOS	AMI
Display	DP/HDMI/LVDS/eDP	HDMI/DP/LVDS/eDP	N/A	Up to 4x DP	Up to 4x DP	1x VGA
I/O Interface	USB/SATA/UART/GPIO	USB/SATA/UART/GPIO	USB/SATA/UART/GPIO	PCIe Gen3 x8 (via x16 slot), PCIe Gen3 x1, M.2 and Mini-PCIe Expansion	PCIe Gen4 x8 (via x16 slot), 2x M.2 2280 M-Key, 1x M.2 2242 B-Key	2x 1GbE, 2x 10GbE 2x USB Type-A 3.2 Gen1
Power Input	ATX or AT 12V+/-5%	ATX or AT 12V+/-5%	ATX or AT 12V+/-5%	12V ±5%	12V ±5%	ATX 12V ±5%
Power Consumption	15W - 54W	15W - 54W	15W - 45W	10W – 54W	15W – 54W	Up to 400W
Operating Temperature	0°C to 60°C	0°C to 60°C -45°C to 85°C (optional)	0°C to 60°C -45°C to 85°C (optional)	0˚C to 60˚C	0˚C to 60˚C	10°C to 35°C
Form Factor	COM Express Type 6 Compact	COM Express Type 6 Compact	COM Express Type7 Basic	Mini-ITX	Mini-ITX	CEB
Dimensions	95 mm x 95 mm	95 mm x 95 mm	125 mm x 95 mm	170mm x 170 mm	170mm x 170 mm	305mm x 267 mm

Product Specifications



1U Edge AI Server



2U Edge AI Server



4U Edge AI Server



Gaming Platform

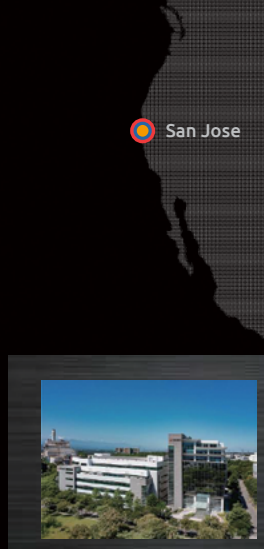


Gaming Platform

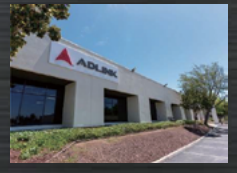
	AXE-5100R7/ R9	AXE-7220TR	AXE-7440TR	ADi-SA6X-RZ-E8K	ADi-SA2X-RZ
AMD Processor	AMD Ryzen™ 7000/9000 Series Processors	AMD EPYC™ 9005/9004 Series Processors	AMD EPYC 9005/9004 Series Processors	AMD Ryzen Embedded 8000 Processors	AMD Ryzen V2000 Processors
Memory	4x DIMM DDR5 5600MT/s UDIMM Up to 128GB	8x DIMM DDR5 6400 R-DIMM MT/s Up to 1TB	8x DIMM DDR5 6400 R-DIMM MT/s Up to 1TB	Dual Channel DDR5 5600 SO-DIMM Up to 64GB	Dual Channel Non-ECC DDR4 3200 Up to 32GB
BIOS	AMI	AMI	AMI	AMI uEFI on 32MB SPI BIOS	AMI uEFI on 32 MB SPI BIOS
Display	1x HDMI	1x VGA	1x VGA	Up to 4x 4K60 Displays	Up to 8x DP (incl. 4K UHD)
I/O Interface	8x GbE Ports, 1x GbE Port Dedicated for IPMI, 2x USB 3.0, 1x USB 3.0 internal	2x 10 GbE RJ45 Ports, 2x GbE Ports (1x GbE is dedicated for IPMI), 2x USB Type-A 3.2 Gen1	2x USB 2.0, 2x 10 GbE RJ45 Ports, 2x GbE Ports (1x GbE is dedicated for IPMI), 2x USB Type-A 3.2 Gen1	PCIe Gen4 x8 (via x16 slot), 2x M.2 2280 M-Key, 1x M.2 2242 B-Key	PCIe Gen3 x8 (via x16 slot), PCIe Gen3 x1, M.2 (M Key, 2242/2260/2280)
Power Input	1+1 300W-800W	1+1 1300W/1600W/2000W	1+1 1600W/2000W	12V ±5%	12V or 24V Input (optional)
Power Consumption	120W	300W	400W	15W – 54W	15W – 54W
Operating Temperature	0°C to 45°C	10°C to 35°C	10°C to 35°C	0°C to 50°C	0°C to 50°C
Form Factor	1U 19” Rackmount	2U 19” Rackmount	4U 19” Rackmount	-	-
Dimensions	438(W) x 420(D) x 43.6(H) mm	438(W) x 450(D) x 87(H) mm	437.5(W) x 650(D) x 176.5(H) mm	208(W) x 221.3(D) x 91(H) mm	265(W) x 240(D) x 91(H) mm

Global Reach, Local Touch

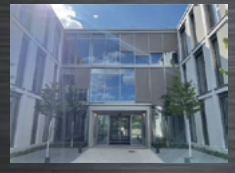
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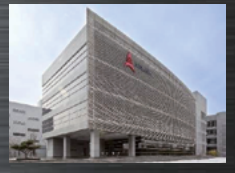
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USA



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Germany



Shanghai
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2 Factories

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USA, Europe, Asia, Taiwan, and China

4 Logistics & Service Centers

USA, Europe, and Asia

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